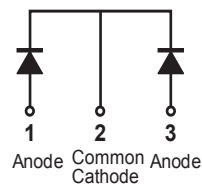


### MBRF3060CT



#### Pin out



#### Description

Littelfuse MBR series Schottky Barrier Rectifier is designed to meet the general requirements of commercial applications by providing high temperature, low leakage and low  $V_F$  products. It is suitable for high frequency switching mode power supply, free-wheeling diodes and polarity protection diodes.

#### Features

- High junction temperature capability
- Guard ring for enhanced ruggedness and long term reliability
- Low forward voltage drop
- High frequency operation
- Common cathode configuration in electrically isolated ITO-220AB package

#### Applications

- Switching mode power supply
- Free-wheeling diodes
- DC/DC converters
- Polarity protection diodes

#### Maximum Ratings

Parameters	Symbol	Test Conditions	Max	Unit
Peak Inverse Voltage	$V_{RWM}$	-	60	V
Average Forward Current	$I_{F(AV)}$	50% duty cycle @ $T_C = 95^\circ\text{C}$ , rectangular wave form	15 (per leg) 30 (total device)	A
Peak One Cycle Non-Repetitive Surge Current (per leg)	$I_{FSM}$	8.3 ms, half Sine pulse	200	A

#### Electrical Characteristics

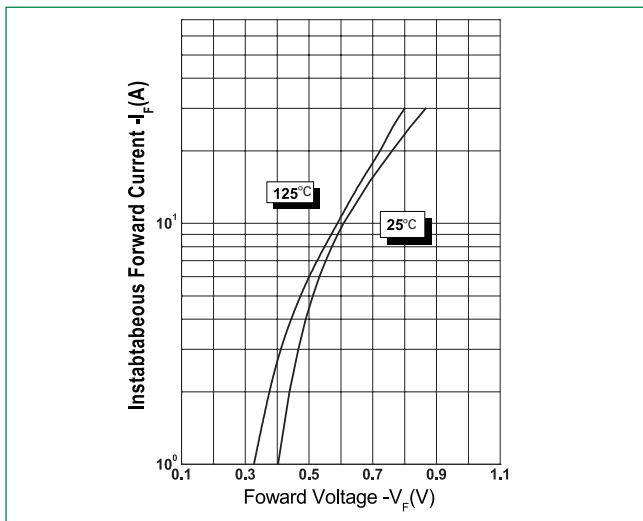
Parameters	Symbol	Test Conditions	Max	Unit
Forward Voltage Drop (per leg) *	$V_{F1}$	@ 15A, Pulse, $T_J = 25^\circ\text{C}$	0.70	V
	$V_{F2}$	@ 15A, Pulse, $T_J = 125^\circ\text{C}$	0.67	
Reverse Current (per leg) *	$I_{R1}$	@ $V_R = \text{rated } V_R$ , $T_J = 25^\circ\text{C}$	1.0	mA
	$I_{R2}$	@ $V_R = \text{rated } V_R$ , $T_J = 125^\circ\text{C}$	100	
Junction Capacitance (per leg)	$C_T$	@ $V_R = 5\text{V}$ , $T_C = 25^\circ\text{C}$ , $f_{\text{SIG}} = 1\text{MHz}$	700	pF
Typical Series Inductance (per leg)	$L_S$	Measured lead to lead 5 mm from package body	8.0	nH
Voltage Rate of Change	$dv/dt$		10,000	V/ $\mu\text{s}$
RSM Isolation Voltage ( $t = 1.0$ second, R. H. $< 30\%$ , $T_A = 25^\circ\text{C}$ )	$V_{\text{ISO}}$	Clip mounting, the epoxy body away from the heatsink edge by more than 0.110" along the lead direction.	4500	V
		Clip mounting, the epoxy body is inside the heatsink.	3500	
		Screw mounting, the epoxy body is inside the heatsink.	1500	

\* Pulse Width  $< 300\mu\text{s}$ , Duty Cycle  $< 2\%$

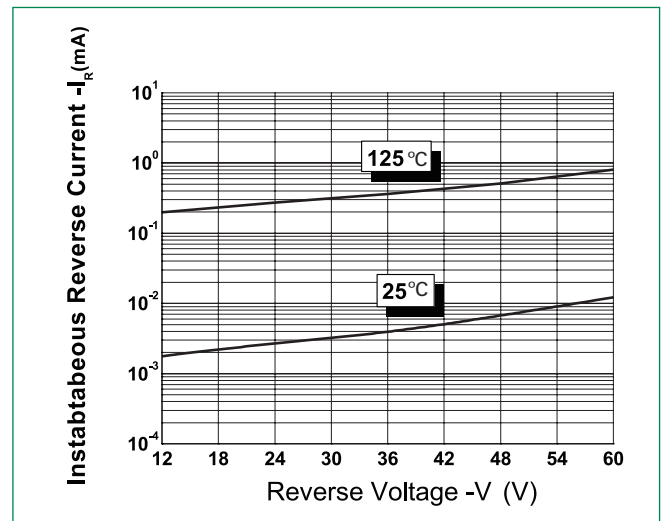
**Thermal-Mechanical Specifications**

Parameters	Symbol	Test Conditions	Max	Unit
Junction Temperature	$T_J$		-55 to +150	°C
Storage Temperature	$T_{stg}$		-55 to +150	°C
Maximum Thermal Resistance Junction to Case	$R_{thJC}$	DC operation	3.0	°C/W
Maximum Thermal Resistance, Case to Heat Sink	$R_{thJA}$	DC operation	60	°C/W
Approximate Weight	wt		2	g
Case Style		ITO-220AB		

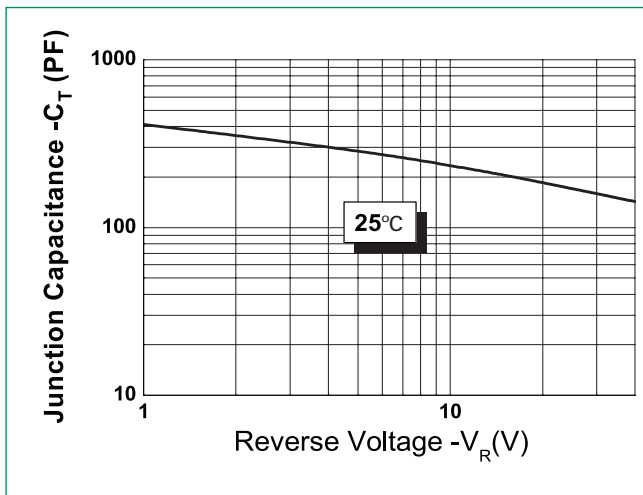
**Figure 1: Typical Forward Characteristics**



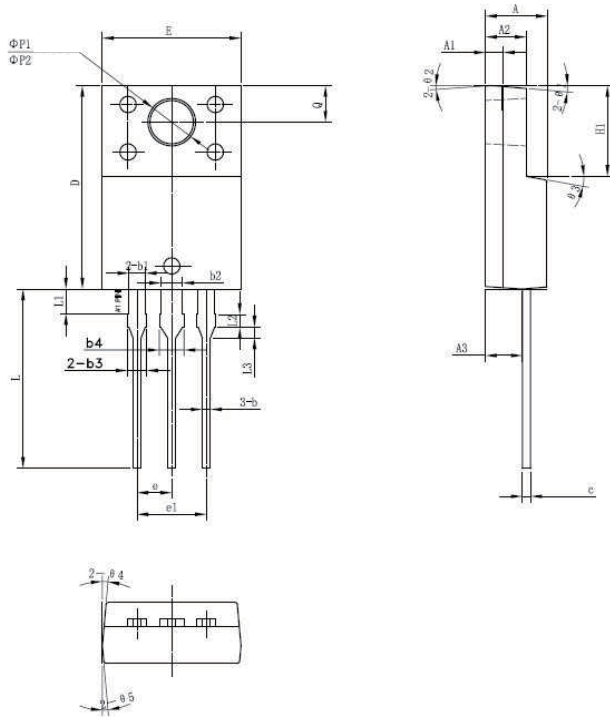
**Figure 2: Typical Reverse Characteristics**



**Figure 3: Typical Junction Capacitance**



### Dimensions- ITO-220AB

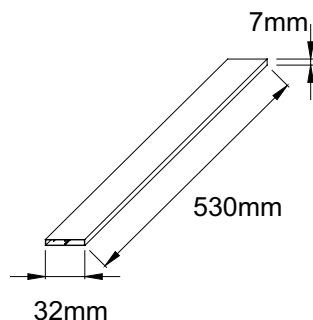


Symbol	Millimeters		
	Min	Typ	Max
<b>A</b>	4.30	4.50	4.70
<b>A1</b>	1.10	1.30	1.50
<b>A2</b>	2.80	3.00	3.20
<b>A3</b>	2.50	2.70	2.90
<b>b</b>	0.50	0.60	0.75
<b>b1</b>	1.10	1.20	1.35
<b>b2</b>	1.50	1.60	1.75
<b>b3</b>	1.20	1.30	1.45
<b>b4</b>	1.60	1.70	1.85
<b>c</b>	0.55	0.60	0.75
<b>D</b>	14.80	15.00	15.20
<b>E</b>	9.96	10.16	10.36
<b>e</b>	-	2.55	-
<b>e1</b>	-	5.10	-
<b>H1</b>	6.50	6.70	6.90
<b>L</b>	12.70	13.20	13.70
<b>L1</b>	1.60	1.80	2.00
<b>L2</b>	0.80	1.00	1.20
<b>L3</b>	0.60	0.80	1.00
<b>ØP1</b>	3.30	3.50	3.70
<b>ØP2</b>	2.99	3.19	3.39
<b>Q</b>	2.50	2.70	2.90
<b>θ1</b>	-	5°	-
<b>θ2</b>	-	4°	-
<b>θ3</b>	-	10°	-
<b>θ4</b>	-	5°	-
<b>θ5</b>	-	5°	-

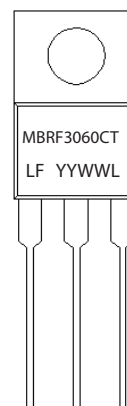
### Packing Options

Part Number	Marking	Packing Mode	M.O.Q
MBRF3060CT	MBRF3060CT	50pcs /Tube	1000

### Tube Specification



### Part Numbering and Marking System



MBR	= Device Type
F	= Package type
30	= Forward Current (30A)
60	= Reverse Voltage (60V)
CT	= Configuration
LF	= Littelfuse
YY	= Year
WW	= Week
L	= Lot Number